**FEATURES** 

- Trench MOS Schottky technology
- Low forward voltage drop, low power losses · High efficiency operation
- Solder bath temperature 275 °C maximum, 10 s per JESD 22-B106
- AEC-Q101 gualified available: Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

## **TYPICAL APPLICATIONS**

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection in commercial, industrial, and automotive application.

## **MECHANICAL DATA**

Case: TO-247AD 3L

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

### Polarity: as marked

Mounting torque: 10 in-lbs maximum

<b>MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER		SYMBOL	VX60170PW	UNIT	
Maximum repetitive peak reverse voltage		V <sub>RRM</sub>	170	V	
Maximum average forward rectified current	per device		60	٨	
(fig. 1)	per diode	IF(AV)	30	A	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load		I <sub>FSM</sub>	350	A	
Operating junction temperature range		T <sub>J</sub> <sup>(1)</sup>	-40 to +175	°C	
Storage temperature range		T <sub>STG</sub>	-40 to +175	C	

#### Note

<sup>(1)</sup> The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta,JA}$ 

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## Dual High Voltage TMBS<sup>®</sup> (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.47$  V at  $I_F = 5.0$  A



PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	2 x 30 A				
V <sub>RRM</sub>	170 V				
I <sub>FSM</sub>	350 A				
V <sub>F</sub> at I <sub>F</sub> = 30 A (T <sub>J</sub> = 125 °C)	0.65 V				
T <sub>J</sub> max.	175 °C				
Package	TO-247AD 3L				
Circuit configuration	Common cathode				

# www.vishay.com



HALOGEN

FREE





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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_J = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
	I <sub>F</sub> = 5 A	T <sub>J</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.61	-	V
	I <sub>F</sub> = 15 A			0.72	-	
Instantanceus forward voltage per diade	I <sub>F</sub> = 30 A			0.79	0.84	
Instantaneous forward voltage per diode	I <sub>F</sub> = 5 A	T <sub>J</sub> = 125 °C		0.47	-	
	I <sub>F</sub> = 15 A			0.57	-	
	I <sub>F</sub> = 30 A			0.65	0.71	
Reverse current at rated V <sub>R</sub> per diode	V <sub>B</sub> = 136 V	T <sub>J</sub> = 25 °C	I <sub>R</sub> (2)	0.0015	-	mA
	v <sub>R</sub> = 150 v	T <sub>J</sub> = 125 °C		2.8	-	
	V <sub>B</sub> = 170 V	T <sub>J</sub> = 25 °C		-	0.2	
	v <sub>R</sub> = 170 v	T <sub>J</sub> = 125 °C		4.5	15	
Typical junction capacitance	4.0 V, 1 MHz		CJ	2800	-	pF

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: Pulse width  $\leq$  5 ms

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	AMETER SYMBOL VX60170PW UN				
Typical thermal resistance per device $R_{\theta JC}^{(1)}$ 0.6		°C/W			

#### Note

<sup>(1)</sup> Thermal resistance junction-to-case to follow JEDEC<sup>®</sup> 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION (Example)								
PREFERRED P/N	PREFERRED P/N UNIT WEIGHT (g) PACKAGE CODE BASE QUANTITY DELIVERY MODE							
VX60170PW-M3/P	5.64	Р	25/tube	Tube				
VX60170PWHM3/P (1)	5.64	Р	25/tube	Tube				

#### Note

(1) AEC-Q101 qualified



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## **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25$ °C, unless otherwise noted)

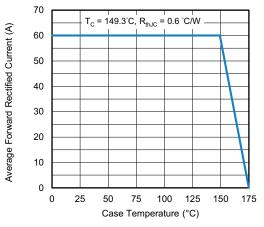


Fig. 1 - Maximum Forward Current Derating Curve

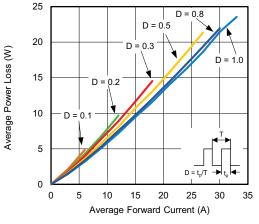


Fig. 2 - Average Power Loss Characteristics

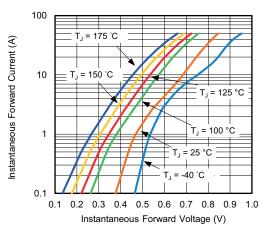


Fig. 3 - Typical Instantaneous Forward Characteristics

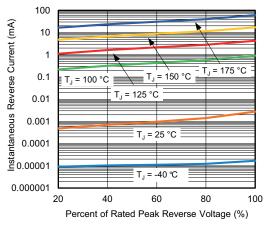


Fig. 4 - Typical Reverse Leakage Characteristics

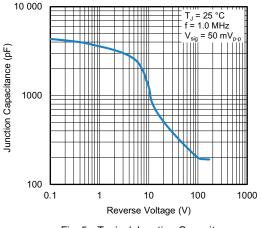


Fig. 5 - Typical Junction Capacitance

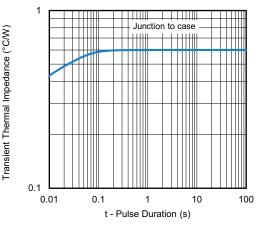


Fig. 6 - Typical Transient Thermal Impedance

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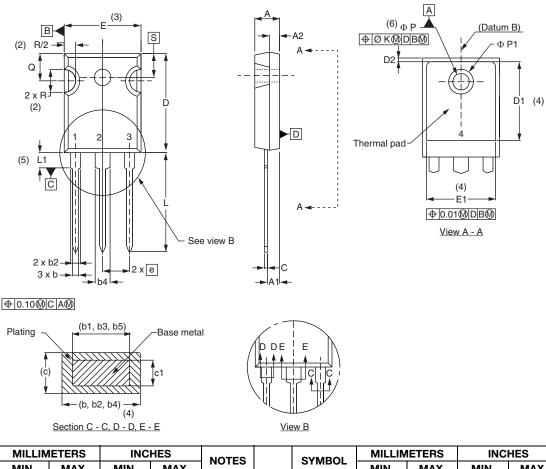
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### PACKAGE OUTLINE DIMENSIONS in millimeters (inches) TO-247AD 3L



CIMBOL	MIN.	MAX.	MIN.	MAX.	NOTED
А	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
с	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STMDOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215 BSC		
ØК	0.254		0.0	0.010	
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		

#### Notes

SYMBOL

<sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

<sup>(3)</sup> Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body

<sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1

<sup>(5)</sup> Lead finish uncontrolled in L1

<sup>(6)</sup> Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

(7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4

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